Parameter	Symbol	Rating	Units
Load Voltage	V_L	100	V
Load Current	I_L	1.1	A
On-Resistance	R_{on}	0.15	Ω
I/O Breakdown Voltage	V_{IO}	5000	Vrms

RoHS compliant   Pb lead-free

SMD-6

DIP-6

AC/DC A

DC   B
Also can be used as a "2 a"

DC   B
Also can be used as a "2 a"
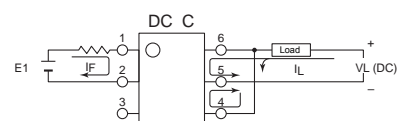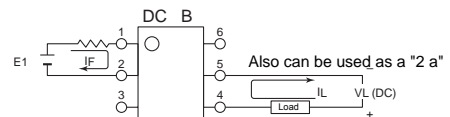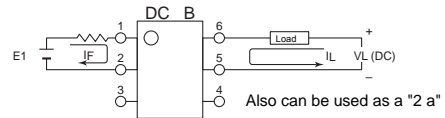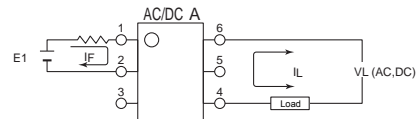
DC C
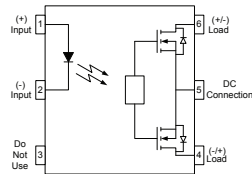
1. LED Anode
2. LED Cathode
4. Drain (MOS FET)
5. Source (MOS FET)
6. Drain (MOS FET)

SUPSiC PhotoRelays

- Long life (No limit on mechanical and electrical lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI
- No have voltaic arc, bounce, and noise More resistant to vibration and impact AC or DC load switching
- Small package size

Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems
- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category	Output Rating		Package	Part No.	Packing Quantity
	Load Voltage	Load Current			
AC/DC	100V	1.1A	DIP-6	GAQV215G1E	50pcs /tube
			SMD-6	GAQV215G1EH	1000pcs /reel

*Turn on/Turn off time

Input

Output

90%
10%

Ton   Toff
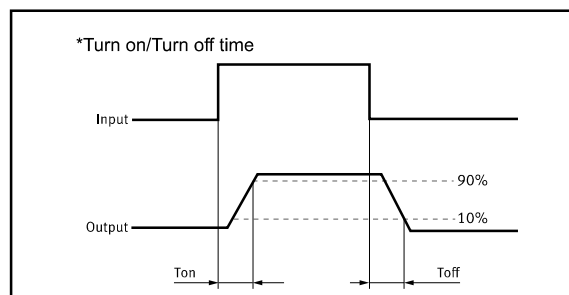
Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Value	Units	Note
Input	Continuous LED Current	I_F	50	mA	
	Peak LED Current	I_{FP}	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	V_R	5	V	
	Input Power Dissipation	P_{In}	75	mW	
Output	Load Voltage	V_L	100	V(AC peak or DC)	
	Load Current	I_L	1.1	A	
	Peak Load Current	I_{Peak}	4.0	A	100ms(1 pulse)
	Output Power Dissipation	Pout	380	mW	
Total Power Dissipation		P_T	450	mW	
I/O Breakdown Voltage		$V_{I/O}$	5000	Vrms	RH=60%, 1min
Operating Temperature		T_{opr}	-40 to 85	℃	
Storage Temperature		T_{stg}	-40 to 100	℃	
Pin Soldering Temperature		T_{sol}	260	℃	10 sec max.

Electrical Characteristics (Ta = 25°C)

Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	V_F		1.2	1.4	V	I_F=10mA
	Operation LED Current	I_{Fon}		0.5	3.0	mA	
	Recovery LED Current	I_{Foff}		0.35	0.5	mA	
	Recovery LED Voltage	V_{Foff}	0.7			V	
Output	On-Resistance	R_{on}		0.3	0.7	Ω	I_F=5mA,I_L=100mA, Time to flow is within 1 sec.
	Off-State Leakage Current	I_{Leak}			1	uA	V_L=Rating
	Output Capacitance	C_{out}		115		pF	V_L=0, f=1MHz
Transmission	Turn-On Time	T_{on}		0.5	5.0	ms	I_F=5mA, I_L=100mA,
	Turn-Off Time	T_{off}		0.35	2.0	ms	
Coupled	I/O Isolation Resistance	$R_{I/O}$	10^{10}			Ω	DC500V
	I/O Capacitance	$C_{I/O}$		0.8	1.5	pF	f=1MHz

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA
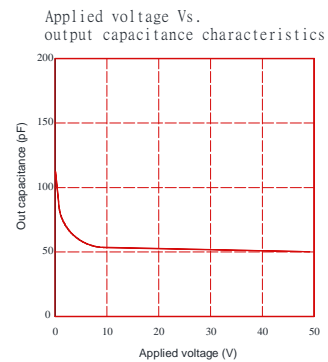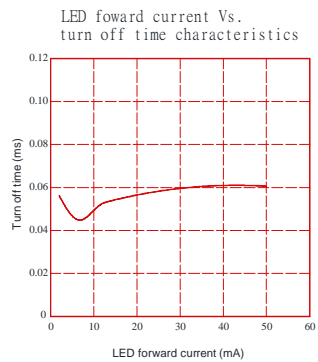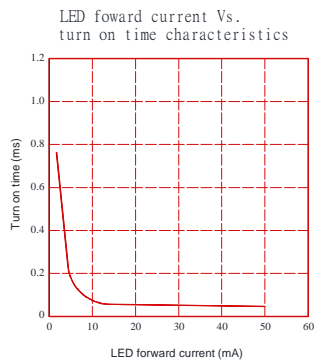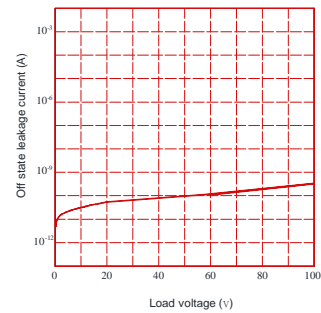
Engineering Data

Load current Vs. Ambient temperature

On resistance Vs. Ambient temperature

Turn on time Vs. Ambient temperature

Turn off time Vs. Ambient temperature

LED operate current Vs. Ambient temperature

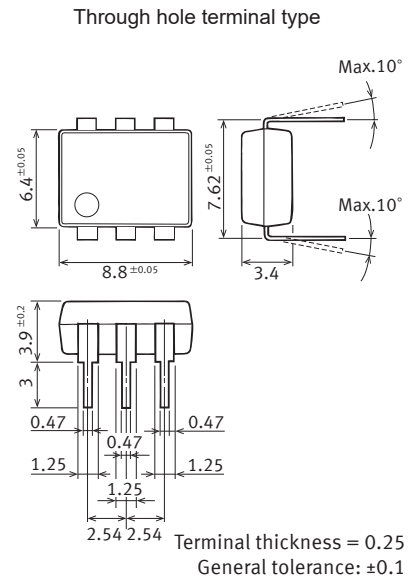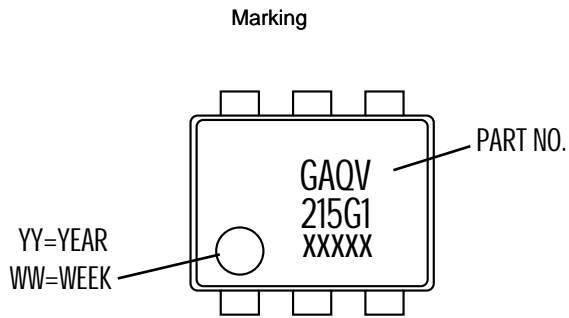LED turn off current Vs. Ambient temperature

LED forward voltage Vs. Ambient temperature
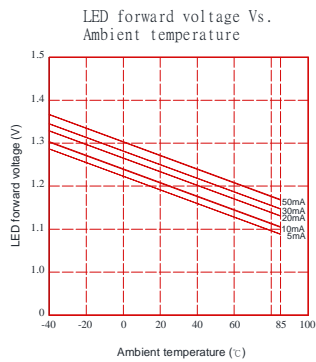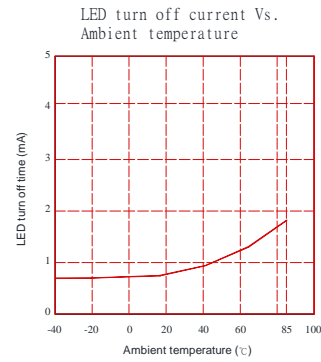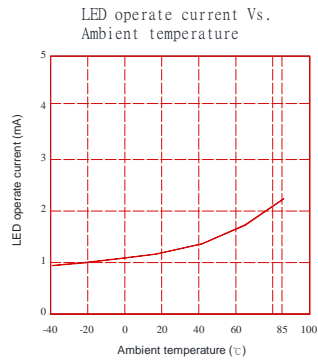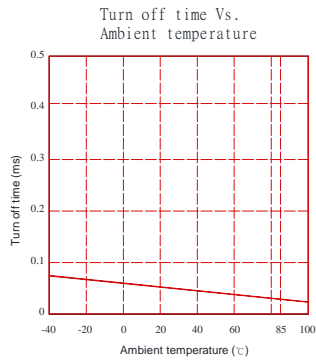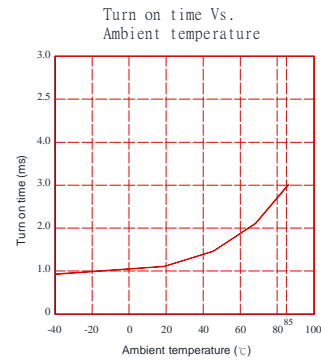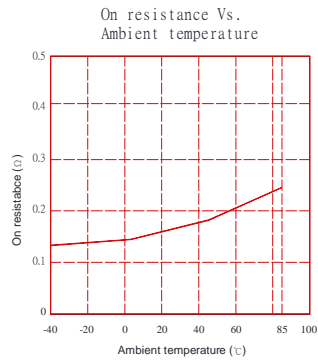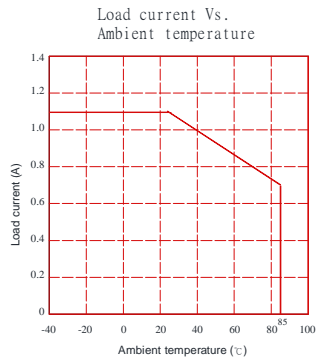
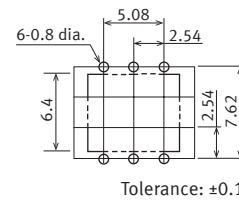Voltage Vs. currennt characteristics of output at MOS portion
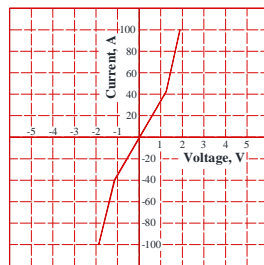
Off state leakage current Vs. Load voltage characteristics

LED foward current Vs. turn on time characteristics

LED foward current Vs. turn off time characteristics

Applied voltage Vs. output capacitance characteristics

Dimensions and DIP-6 Package   Unit: mm

Through hole terminal type

Marking

GAQV
215G1
XXXXX

PART NO.

YY=YEAR
WW=WEEK

Max.10°

Max.10°

6.4 ±0.05

7.62 ±0.05

8.8 ±0.05

3.4

3.9 ±0.2

3

0.47   0.47
0.47
1.25   1.25
1.25
2.54 2.54   Terminal thickness = 0.25
General tolerance: ±0.1

PC board pattern (Bottom view)

6-0.8 dia.

5.08

2.54

6.4

2.54

7.62

Tolerance: ±0.1
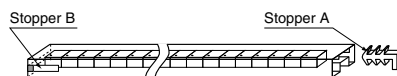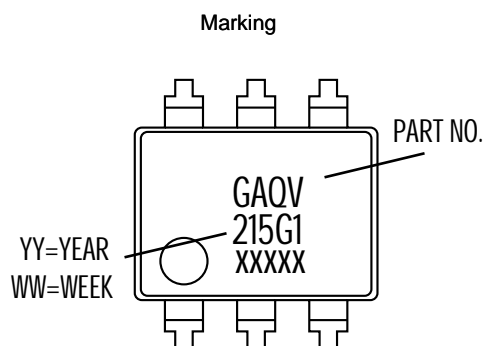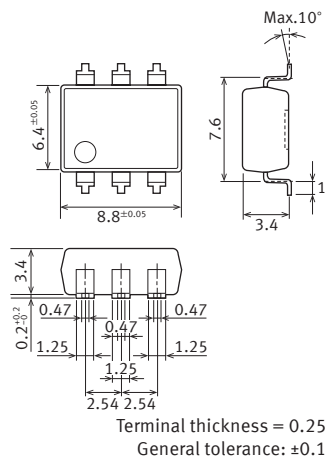
DIP Tape dimensions   Unit : mm

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.
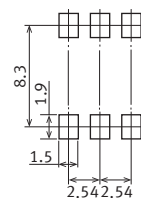
Stopper B   Stopper A

Dimensions and SMD-6 Package   Unit: mm

Marking

PART NO.

GAQV
215G1
XXXXX

YY=YEAR
WW=WEEK

Surface mount terminal type

Max.10°

6.4 ±0.05

7.6

8.8±0.05

3.4

1

3.4

0.2⁺⁰·²

0.47   0.47   0.47
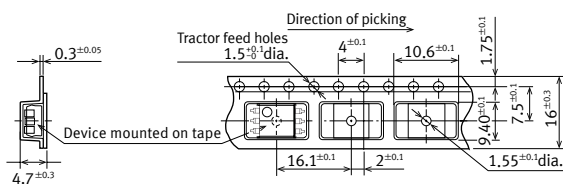
1.25   1.25   1.25

2.54 2.54

Terminal thickness = 0.25
General tolerance: ±0.1

Recommended mounting pad
(Top view)

8.3

1.9

1.5

2.54 2.54

Tolerance: ±0.1

Tape dimensions (tape reel)

381.0±2.0

2.0±0.5

Ø13.0±0.5

80.0±1.0

Label sticking position

Top cover tape
thickness 0.10 max.

Embossed
carrier tape

Embossed
cavity

Direction of picking

Tractor feed holes
1.5⁺⁰·¹dia.

0.3⁺⁰·⁰⁵

4⁺⁰·¹   10.6⁺⁰·¹

1.75⁺⁰·¹

Device mounted on tape

16.1⁺⁰·¹   2⁺⁰·¹

9.40⁺⁰·¹

7.5⁺⁰·¹

16⁺⁰·³

1.55⁺⁰·¹dia.

4.7⁺⁰·³
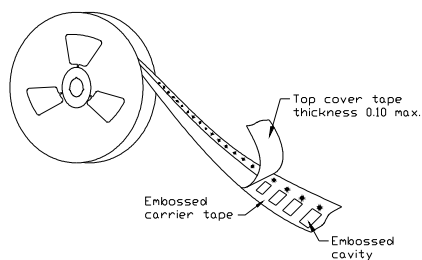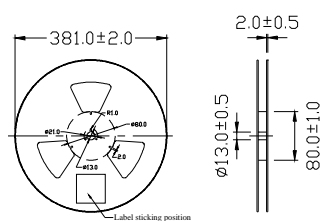
Using Methods

Examples of resistance value to control LED forward current (I_F=5mA)
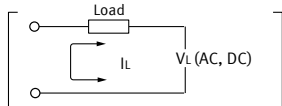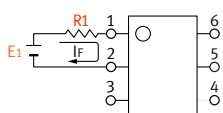
E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9K Ω
24V	4.1K Ω

LED forward current must be more than 5mA , at $I(MIN)$,and less than 30mA , at $I(MAX)$.
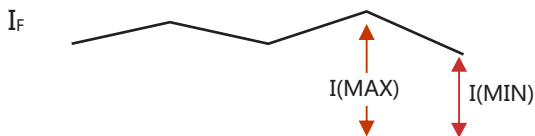
Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):
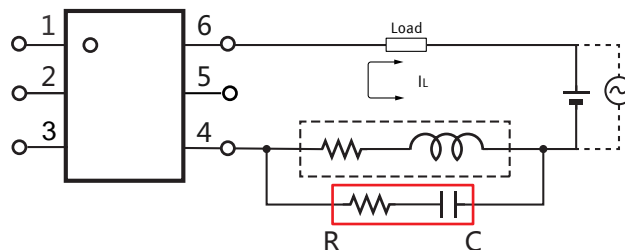
Characteristic	Symbol	Min	Typ.	Max	Unit
Forward current	I_F	5.0	7.0	30	mA

Protection Circuit

Clamp diode is connected in parallel with the load.
Absorb capacity with external diode.
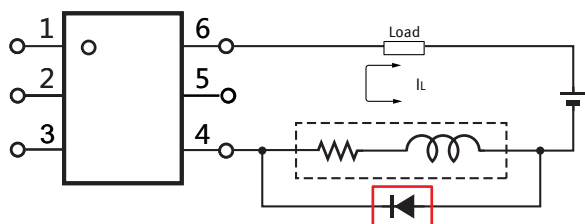
CR Snubber is connected in parallel with the load.
Absorb capacity with buffer capacity.

When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective.
Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.